

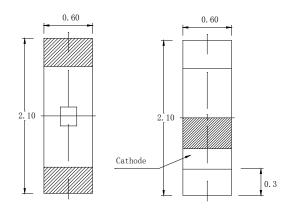
Features

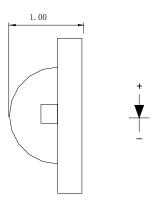
- 2.1mm*1.0mm SMT LED, Super thin (0.6H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Product

Applications

• Backlight and Indicator

Package Dimensions





Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

www.FantasyLeds.com

Sales@FantasyLeds.com

Form No: Rev: V.1 Page: 1 of 6
Approved By: Prepared By: Date:



FSL-2110060PG-KXSNZPR

Selection Guide

Part No	Lens Type	Dice	Emitted Color
FSL-2110060PG-KXSNZPR	Water Clear	GaN	Pure Green

Electrical / Optical Characteristics At Ta=25 °C

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity		180	450	mcd	IF=20mA
201/2	Viewing Angle		130		deg	IF=20mA
入 Peak	Peak Emission Wavelength		518		nm	IF=20mA
入 d	Dominant Wavelength	520	530	535	nm	IF=20mA
$\triangle \lambda$	Spectral Line Half-Width		20		nm	IF=20mA
VF	Forward Voltage	2.8	3.4	3.95	V	IF=20mA
IR	Reverse Current			10	μА	VR 5V

Note:

Absolute Maximum Ratings At Ta=25℃

Parameter	Pure Green	Unit	
Power Dissipation	110	mW	
Peak Forward Current[1]	100	mA	
Continuous Forward Current	30	mA	
Dreading Linear From30℃	0.5	mA/°C	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold(HBM)	150	V	
Operating Temperature Range	-20°C to + 80°C		
Storage Temperature Range	-30°C to + 100°C		
Soldering Condition	260°C For 5 Seconds		

Note:

 $1.\ 1/10 Duty Cycle,\ 0.1 ms Pulse Width$

Form No: Rev: V.1 Page: 2 of 6
Approved By: Prepared By: Date:

 $^{1.\,\}theta1/2$ is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value



Electrical Optical Characteristics Curves At Ta=25 °C

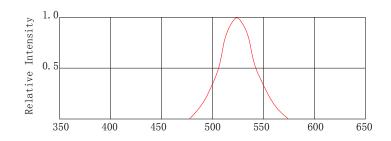


Fig. 1 Relative Intensity vs. Wavelength

Wavelength λ (nm)

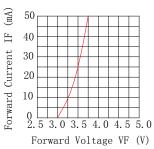


Fig. 2 Forward Current VS. Forward Voltage

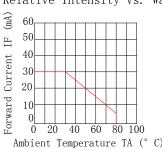


Fig. 3 Forward Current Derating Curve

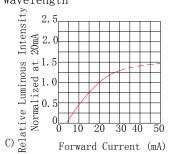
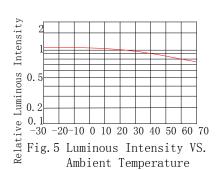
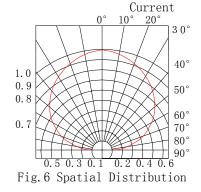


Fig. 4 Relative Luminous
Intensity VS. Forward





Form No: Rev: V.1 Page: 3 of 6
Approved By: Prepared By: Date:





Bin Range Of Luminous Intensity

Symbol	Bin Code	Min.	Max.	Unit	Condition
Iv	Q	72	112	mcd	IF=20mA
	R	112	180		
	S	180	280		
	T	280	450		

Bin Range Of Dominate Wavelength

Symbol	Bin Code	Min.	Max.	Unit	Condition
	X	520	525		
Iv	Y	525	530	mcd	IF=20mA
	Z	530	535		

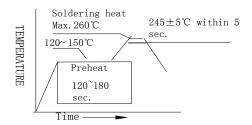
Notes:

- 1. Tolerance of Luminous Intensity +/-20 $\!\%$
- 2. Tolerance of Forward Voltage +/-0.2V
- 3. Tolerance of the Dominate Wavelength +/- 2nm

Form No : Rev : V.1 Page: 4 of 6
Approved By: Prepared By: Date:



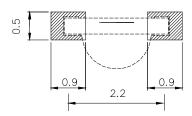
SMT Reflow Soldering Instructions



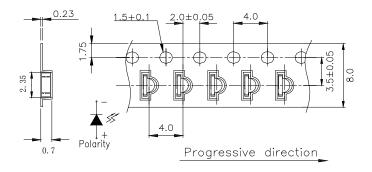
Notes:

- Selles gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a
 wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must
 be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Package Specifications (Units: mm (inches))



Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in $5\sim30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept in 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

Form No: Rev: V.1 Page: 5 of 6

Approved By:

Prepared By:

Date:



FSL-2110060PG-KXSNZPR

Reliability Test Items Conditions

Classification	Test Item	Test Conditions	Test hours	Result
	Operation Life	Connect with a power IF=20mA Ta=Under room temperature	1000Hrs	0/20
	High Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	High Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C ~±5°C ~+85°C ~±5°C 5min 10sec 5min	300 Cycles	0/20
Test	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	$V_F(V)$	IF=20mA	Over U×1.2
Reverse current	Ir(µA)	V _R =5V	Over U×2
Luminous intensity	Iv(mcd)	Ir=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

Form No: Rev: V.1 Page: 6 of 6
Approved By: Prepared By: Date: